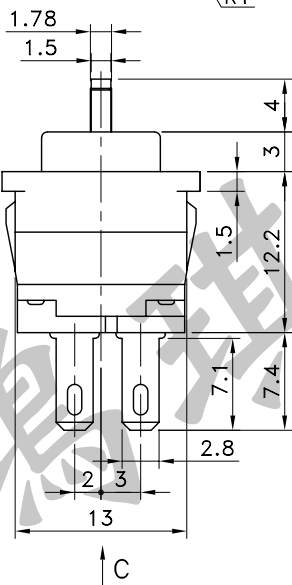
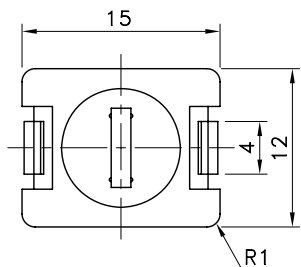
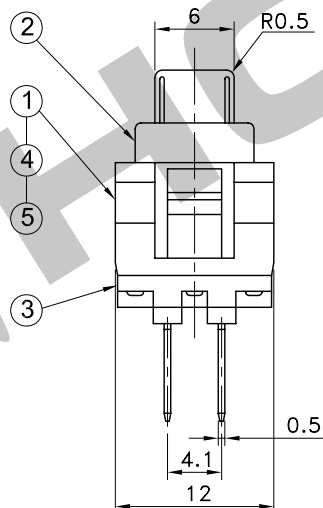


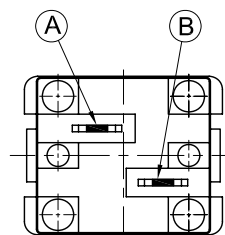
5	Contact Ball	Brass	Au Plating
4	Spring	Stainless	
3	Back PCB Terminal Assembly	Compose Resin , Brass	Ag Plating Assembly
2	Stem	Compose Resin	
1	Holder	Compose Resin	
No.	Parts	Material	Finish



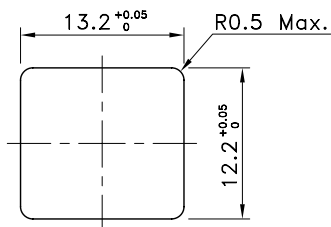
P.C.B TERMINAL POSITION



VIEW C



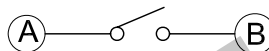
CIRCUIT ARRANGEMENT



Panel Thickness: t 1.2m

SOLDERING CONDITIONS

	Temperature (°C)	Time (Sec.)
Manual Soldering	300	5



SPECIFICATIONS

1. Rating : DC 24V 50mA
2. Contact Resistance : 100mΩ Max.
3. Insulation Resistance : 100MΩ Min. at DC 100V
4. Dielectric Strength : AC 250V for 1 Minute
5. Operating Force : 100±30gf
6. Stroke : 2.5±0.3mm
7. Life : 2,000,000 Cycles (DC 12V 5mA)
8. Operating Temperature Range : -10~+55°C

REVISION:

DATE:

REVISION:

DATE:

UNIT:mm

THIRD ANGLE PROJECTION METHOD

TOL. UNLESS OTHERWISE STATED:±0.3

CODE NO.:HCH-1670

ISSUED

CONFIRMED

PART NO.

John

Elvis

HCH
ISO9001 Certified
ISO14001 Certified

HORNG CHIH

鴻琪股份有限公司

PTS-193

2010.05.31

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